

L Number	Hits	Search Text	DB	Time stamp
4	21	bond\$3 adj pad adj structure and void\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/10 11:53
-	34	bonding adj pad same voids		2004/06/10 11:43